# **Tyrone Camarero Specifications**

# Camarero: ADI200A3S-436

# Key Feature

The ADI200A3S-436 Storage Server is designed for scalable, high-throughput storage deployments in data center and edge environments. It supports modular expansion, Intel's 4th & 5th Gen based dual CPUs, and flexible I/O fabrics to deliver predictable performance at scale. Leveraging state-of-the-art PCIe Gen5 integration and multi-tier storage architecture, the system enables seamless scaling from capacity-centric workloads to latency-sensitive access patterns.

- Supports Dual Intel® Xeon® 4th/5th Gen processors
- Supports 8+8 DDR5 RDIMM Expandable Memory
- 5 x16 PCle + 1 x8 PCle 5.0 Expansion Slots
- Latest AST2600 BMC Controller iKVM, vMedia support
- Support 36 x 2.5"/3.5" Data drives + 2 x 2.5" hot-swap OS drives
- Dual 1GbE(RJ45) by Broadcom BCM5720
- 1300W 80+ Titanium Redundant Power Supply











### Processor

**Processor** Supports Dual Intel Xeon® 4th/5th Gen

CPUs of TDP upto 300W (E1

(LGA-4677-X))

## **System Memory**

Memory Capacity Supports 8+8 DDR5 RDIMM

Expandable Memory,

Max Frequency 5600/4800MHz Max Capacity 256GB/DIMM, Max System Memory 4TB(3DS RDIMM)

# **Expansion Slot**

PCI-Express 5 x16 PCIe/CXL1.1 + 1 x8 PCIe 5.0 (HHFL)

#### **Ports**

Ports 1 x RJ45 GbE connector for BMC

dedicate management port

(RTL8211E)

2 x 1GbE (RJ45) by Broadcom

BCM5720

2 x USB 3.0 Type A Ports (Front) 2 x USB 3.0 Type A Ports (Rear) 1 x DB-15 VGA connector 1 x external UID/switch button

#### **Environment**

**Temperature** Operating Temperature : 10°C ~ 35°C

Non Operating Temperature : 40°C ~

70°C

**Humidity** Non operation humidity: 20% ~ 90%

(Non-condensing)

#### Front Panel

**LED** 1 x Power LED Button

1x Alert LED

1 x HDD Activity LED 1 x LAN Activity LED 1 x Reset Button 1x UID LED Button

## Drive bays

**HDD Bays** Supports 36 x 2.5"/3.5" Hot Swappable

Bays (24Bay 12G + 12Bay 12G expander

controller based backplane)

Supports 2 x 2.5" hot-swap SATA OS

drives (7mm)

Supports 2 x M.2 2280 PCle Gen4.0 x4

(Onboard)

## **Power Supply**

Power Supply 1300W 80+ Titanium Redundant

Power Supply

## Security

Security TPM 2.0

# Form Factor

Form Factor 4U Rackmount

Gross Weight 42 Kg

**Dimensions** 680(L) x 430(W) x 174(H) mm

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